

Applications

- DSSS 5 GHz WLAN (IEEE802.11a)
- DSSS 5 GHz WLAN (IEEE802.11n)
- Access Points, PCMCIA, PC cards

Features

- High output power amplifier
 26dBm at 5V
- External Analog Reference Voltage (V_{REF}) for maximum flexibility
- Buffered, temperature compensated power detector
- 3% EVM, @26dBm, 64 QAM, 54 Mbps
- 32 dB Gain
- Lead Free, RoHS compliant, halogen free MSL3 package
- 20 pin 4 mm x 4 mm x 0.9 mm QFN

Ordering Information

Part Number	Package	Remark
SE5004L	20 Pin QFN	Samples
SE5004L-R	20 Pin QFN	Tape and Reel
SE5004L-EK1	Evaluation Kit	Standard

Functional Block Diagram

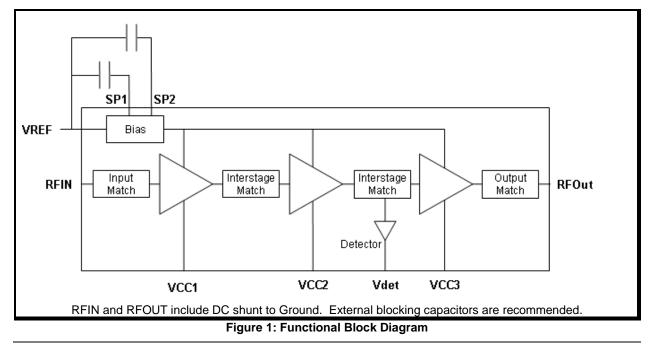
Product Description

The SE5004L is a 5GHz power amplifier offering high linear power for wireless LAN applications. The SE5004L incorporates a power detector for closed loop monitoring and control of the output power.

The SE5004L offers high integration for a simplified design, providing quicker time to market and higher application board production yield. The device integrates the input match, the inter-stage match, the output match, the power detector with 15dB of dynamic range and a 3.8GHz notch filter. Only 6 external decoupling capacitors are required to complete the design.

For wireless LAN applications, the device meets the requirements of IEEE802.11a & 802.11n, and delivers approximately 26dBm of linear output power at 5V.

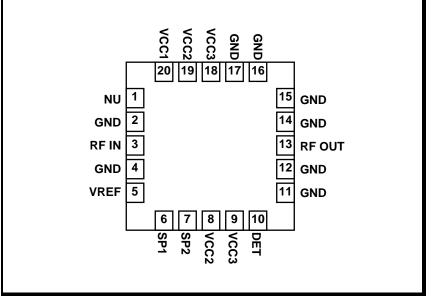
The SE5004L integrates temperature compensated bias voltage generators. A 2.85V reference voltage on VREF is all that is required to enable or disable the power amplifier.

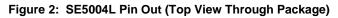


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Pin Out Diagram





Pin Out Description

Pin No.	Name	Description
1	NU	Pin is not used, and is open circuit in the package
2	GND	Ground
3	RFin	Power Amplifier RF input, DC block required
4	GND	Ground
5	V _{REF}	Reference Voltage
6	SP1	Port for optional capacitor to improve dynamic EVM
7	SP2	Port for optional capacitor to improve dynamic EVM
8	VCC2	Second Stage Supply Voltage
9	VCC3	Third Stage Supply Voltage
10	DET	Analog Power Detector Output
11,12	GND	Ground
13	RF OUT	Power Amplifier RF Output
14-17	GND	Ground
18	VCC3	Third Stage Supply Voltage
19	VCC2	Second Stage Supply Voltage
20	VCC1	First Stage Supply Voltage

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Absolute Maximum Ratings

These are stress ratings only. Exposure to stresses beyond these maximum ratings for a long period of time may cause permanent damage to, or affect the reliability of the device. Avoid operating the device outside the recommended operating conditions defined below. This device is ESD sensitive. Handling and assembly of this device should be at ESD protected workstations.

Symbol	Definition	Min.	Max.	Unit
Vcc	Supply Voltage on pins VCC3	-0.3	+6	V
VCC	Supply Voltage on pins VCC1, VCC2	-0.3	VCC3	V
V_{REF}	Power Amplifier Enable and Reference Voltage	-0.3	3.6	V
RFin	RF Input Power, RFout into 50Ω match, T _{CASE_MAX} = 85C	-	6	dBm
Тѕтс	Storage Temperature Range	-40	160	°C
Tj	Maximum Junction Temperature	-	160	°C
ESD _{HBM}	JEDEC JESD22-A114 all pins	-	500	V

Recommended Operating Conditions

Symbol	Parameter	Min.	Max.	Unit
Vcc	Supply Voltage VCC3	3.0	5.5	V
VCC	Supply Voltage VCC1, VCC2	3.0	VCC3	V
T _{CASE_MAX}	Maximum Case Temperature	-40	85	°C
Vref	Reference Voltage	2.8	2.9	V

DC Electrical Characteristics

Conditions: Vcc = 5.0V, V_{REF} = 2.85 V, T_A = 25 °C, as measured on Skyworks Solutions' SE5004L-EK1 evaluation board, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ICC-802.11a	Supply Current	P _{OUT} = 26 dBm, 54 Mbps, 64 QAM	-	600	800	mA
lqc	Quiescent Current	No RF	-	300	-	mA
IOFF	Supply Current	V _{REF} = 0 V, No RF	-	0.5	10	μA
IEN	Bias Control Current	$V_{REF} = V_{REF H}$ Internal 2K Ω pull down resistor	-	10	-	mA
V _{REF} H	Reference Voltage Enabled	-	2.80	2.85	2.9	V
V _{REF} L	Reference Voltage Disabled	-	0	-	0.5	V



AC Electrical Characteristics

802.11a AC Electrical Characteristics

Conditions: Vcc = 5.0 V, V_{REF} = 2.85 V, f = 5.4 GHz, T_A = 25 °C, as measured on Skyworks Solutions' SE5004L-EK1 evaluation board, unless otherwise noted

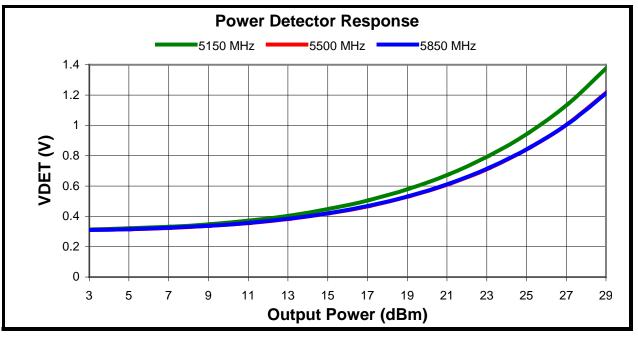
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
f∟-∪	Frequency Range	-	5.15	-	5.85	GHz	
		802.11a, 54Mbps, 64 QAM, 3% EVM	25.5	26	-		
Pout	Output Power	802.11a, 54Mbps, 64 QAM, 2.5% EVM	24.5	25		dBm	
		802.11n, MCS0, Mask Compliant	-	29	-		
P _{1dB}	Output 1dB compression point	No modulation	30	34	-	dBm	
S 21	Small Signal Gain	Pın = -25 dBm	30	32	-	dB	
ΔS 21	Gain Variation	Within each UNII Band	-	3	-	dB	
ΔS21 3.8	Gain at 3.8GHz	Pin = -25 dBm	-	-	0	dB	
2f					45		
Зf	Harmonic	Pouτ = 26 dBm, 5V	-	-	-45	dBm/MHz	
tr, tr	Rise and Fall Time	-	-	0.15	0.3	us	
STAB	Stability	Pouτ = 26 dBm, VCC = 5V, 54 Mbps, 64 QAM, VSWR = 6:1, all phases	All non-harmonically related outputs less than -50 dBc/100 kHz				
Rugged	Tolerance to constant input power into a mismatch load	Pıℕ = -10dBm, CW, VSWR = 6:1, all phases	No damage				



Power Detector

Conditions: Vcc = 5.0 V, V_{REF}=2.85V, f = 5.4 GHz, T_A = 25 °C, as measured on Skyworks Solutions' SE5004L-EK1 evaluation board, unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
PDR	Pout detect range	-	0	-	P _{1dB}	dBm
VDET	Detector voltage	Роит = 27 dBm	-	1.000	-	V
VDET		POUT = NO RF	-	0.325	-	V
ERR _{DET}	Detector Accuracy	[△] P _{OUT} at constant V _{DET} , 5.15 GHz – 5.70 GHz 5.70 GHz – 5.85 GHz	-0.5 -0.5	-	+0.5 +0.5	dB
		$^{\triangle}P_{OUT}$ at constant V _{DET} , VSWR = 3:1	-1.5		+1.5	dB
PDZout	Output Impedance	-	-	0.7	-	KΩ
PDZLOAD	DC load impedance	-	-	26.5	-	KΩ







Package Diagram

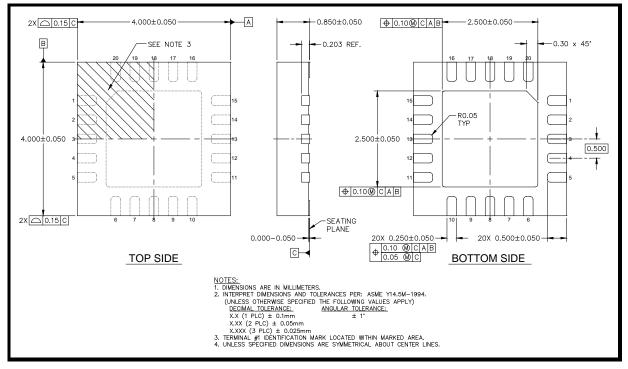
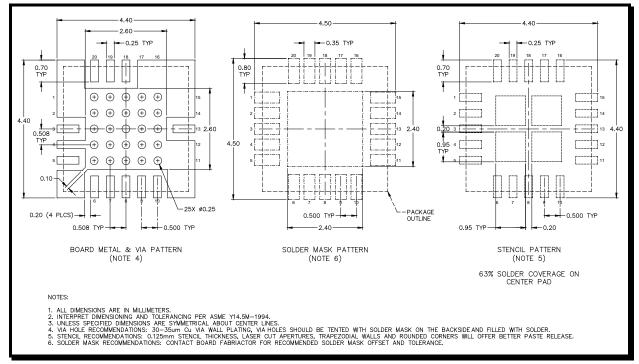


Figure 4: SE5004L Package Information





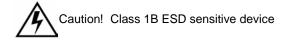
Recommended Land and Solder Pattern

Figure 5: SE5004L Recommended Land Pattern

Package Handling Information

Because of its sensitivity to moisture absorption, instructions on the shipping container label must be followed regarding exposure to moisture after the container seal is broken, otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly. The SE5004L is capable of withstanding a Pb free solder reflow. Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. If the part is manually attached, precaution should be taken to insure that the device is not subjected to temperatures above its rated peak temperature for an extended period of time. For details on both attachment techniques, precautions, and handling procedures recommended, please refer to:

- "Quad Flat No-Lead Module Solder Reflow & Rework Information", Document Number QAD-00045
- "Handling, Packing, Shipping and Use of Moisture Sensitive QFN", Document Number QAD-00044





Branding Information

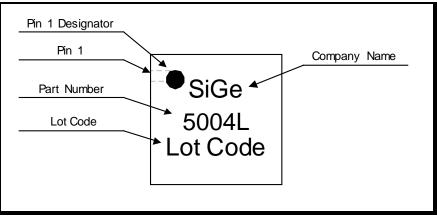


Figure 6: SE5004L Branding Information

Tape and Reel Information

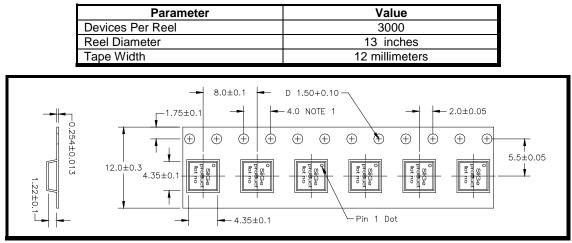


Figure 7: SE5004L-R Tape and Reel Information